## SSD1815B

## Advance Information

## LCD Segment / Common Driver with Controller CMOS

SSD1815B is a single-chip CMOS LCD drivers with controllers for dot-matrix graphic liquid crystal display system. SSD1815B is capable to drive 132 Segments, 64 Commons and 1 icon line by its 197 high voltage driving output.

SSD1815B display data directly from their internal $132 \times 65$ bits Graphic Display Data RAM (GDDRAM). Data/Commands are sent from common MCU through 8-bit Parallel or Serial Interface. The selection of whether 6800- or 8080-series compatible Parallel Interface or Serial Peripheral Interface is done by hardware pins configuration.

SSD1815B embeds a DC-DC Converter, an On-Chip Bias Divider and an On-Chip Oscillator which reduce the number of external components. With the advanced design on minimizing power consumption and die/package layout, SSD1815B is suitable for any portable battery-driven applications requiring a long operation period with a compact size.

## FEATURES

Dot-matrix Display with separated Icon Line, $132 \times 64+1$ Icon Line
Single Supply Operation, 2.4 V ~ 3.5 V
Minimum -12.0V LCD Driving Output Voltage
Low Current Sleep Mode
On-Chip Voltage Generator or External LCD Driving Power Supply Selectable
2X / 3X / 4X On-Chip DC-DC Converter
On-Chip Oscillator
Programmable Multiplex ratio in dot-matrix display area, 1Mux ~ 64Mux
On-Chip Bias Divider
Programmable bias ratio, $1 / 4,1 / 5,1 / 6,1 / 7,1 / 8,1 / 9$
8 -bit 6800-series Parallel Interface, 8 -bit 8080 -series Parallel Interface and Serial Peripheral Interface
On-Chip 132 X 65 Graphic Display Data RAM
Re-mapping of Row and Column Drivers
Vertical Scrolling
Display Offset Control
64 Level Internal Contrast Control
External Contrast Control
Programmable LCD Driving Voltage Temperature Coefficients
Available in Gold Bump Die and TAB (Tape Automated Bonding) Package

## ORDERING INFORMATION

Table 1 SSD1815B Ordering Information

| Ordering Part <br> Number | Seg | Com | Default Bias | Package Form | Reference |
| :---: | :---: | :---: | :---: | :---: | :---: |
| SSD1815BZ | 132 | $64+1$ | $1 / 9,1 / 7$ | Gold Bump Die <br> SSD1815BT <br> SSD1815BT2 |  |

## BLOCK DIAGRAM



Figure 1 SSD1815B Block Diagram

PIN ARRANGEMENT


Figure 2 SSD1815B Gold Bump Die Pin Assignment

Table 2 SSD1815B Gold Bump Die Pad Coordinates


| PAD \# | NAME | X | Y | PAD \# | NAME | X | Y | PAD \# | NAME | X | Y |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 137 | SEG0 | 4997.65 | 751.98 | 203 | SEG66 | -38.15 | 751.98 | 269 | ROW32 | -5285.18 | 757.23 |
| 138 | SEG1 | 4921.35 | 751.98 | 204 | SEG67 | -114.45 | 751.98 | 270 | ROW33 | -5285.18 | 680.93 |
| 139 | SEG2 | 4845.05 | 751.98 | 205 | SEG68 | -190.75 | 751.98 | 271 | ROW34 | -5285.18 | 604.63 |
| 140 | SEG3 | 4768.75 | 751.98 | 206 | SEG69 | -267.05 | 751.98 | 272 | ROW35 | -5285.18 | 528.33 |
| 141 | SEG4 | 4692.45 | 751.98 | 207 | SEG70 | -343.35 | 751.98 | 273 | ROW36 | -5285.18 | 452.03 |
| 142 | SEG5 | 4616.15 | 751.98 | 208 | SEG71 | -419.65 | 751.98 | 274 | ROW37 | -5285.18 | 375.73 |
| 143 | SEG6 | 4539.85 | 751.98 | 209 | SEG72 | -495.95 | 751.98 | 275 | ROW38 | -5285.18 | 299.43 |
| 144 | SEG7 | 4463.55 | 751.98 | 210 | SEG73 | -572.25 | 751.98 | 276 | ROW39 | -5285.18 | 223.13 |
| 145 | SEG8 | 4387.25 | 751.98 | 211 | SEG74 | -648.55 | 751.98 | 277 | ROW40 | -5285.18 | 146.83 |
| 146 | SEG9 | 4310.95 | 751.98 | 212 | SEG75 | -724.85 | 751.98 | 278 | ROW41 | -5285.18 | 70.53 |
| 147 | SEG10 | 4234.65 | 751.98 | 213 | SEG76 | -801.15 | 751.98 | 279 | ROW42 | -5285.18 | -5.78 |
| 148 | SEG11 | 4158.35 | 751.98 | 214 | SEG77 | -877.45 | 751.98 | 280 | ROW43 | -5285.18 | -82.08 |
| 149 | SEG12 | 4082.05 | 751.98 | 215 | SEG78 | -953.75 | 751.98 | 281 | ROW44 | -5285.18 | -158.38 |
| 150 | SEG13 | 4005.75 | 751.98 | 216 | SEG79 | -1030.05 | 751.98 | 282 | ROW45 | -5285.18 | -234.68 |
| 151 | SEG14 | 3929.45 | 751.98 | 217 | SEG80 | -1106.35 | 751.98 | 283 | ROW46 | -5285.18 | -310.98 |
| 152 | SEG15 | 3853.15 | 751.98 | 218 | SEG81 | -1182.65 | 751.98 | 284 | ROW47 | -5285.18 | -387.28 |
| 153 | SEG16 | 3776.85 | 751.98 | 219 | SEG82 | -1258.95 | 751.98 | 285 | ROW48 | -5285.18 | -463.58 |
| 154 | SEG17 | 3700.55 | 751.98 | 220 | SEG83 | -1335.25 | 751.98 | 286 | ROW49 | -5285.18 | -539.88 |
| 155 | SEG18 | 3624.25 | 751.98 | 221 | SEG84 | -1411.55 | 751.98 | 287 | ROW50 | -5285.18 | -616.18 |
| 156 | SEG19 | 3547.95 | 751.98 | 222 | SEG85 | -1487.85 | 751.98 | 288 | ROW51 | -5285.18 | -692.48 |
| 157 | SEG20 | 3471.65 | 751.98 | 223 | SEG86 | -1564.15 | 751.98 | 289 | ROW52 | -5285.18 | -768.78 |
| 158 | SEG21 | 3395.35 | 751.98 | 224 | SEG87 | -1640.45 | 751.98 |  |  |  |  |
| 159 | SEG22 | 3319.05 | 751.98 | 225 | SEG88 | -1716.75 | 751.98 |  |  |  |  |
| 160 | SEG23 | 3242.75 | 751.98 | 226 | SEG89 | -1793.05 | 751.98 |  |  |  |  |
| 161 | SEG24 | 3166.45 | 751.98 | 227 | SEG90 | -1869.35 | 751.98 |  |  |  |  |
| 162 | SEG25 | 3090.15 | 751.98 | 228 | SEG91 | -1945.65 | 751.98 |  |  |  |  |
| 163 | SEG26 | 3013.85 | 751.98 | 229 | SEG92 | -2021.95 | 751.98 |  |  |  |  |
| 164 | SEG27 | 2937.55 | 751.98 | 230 | SEG93 | -2098.25 | 751.98 |  |  |  |  |
| 165 | SEG28 | 2861.25 | 751.98 | 231 | SEG94 | -2174.55 | 751.98 |  |  |  |  |
| 166 | SEG29 | 2784.95 | 751.98 | 232 | SEG95 | -2250.85 | 751.98 |  |  |  |  |
| 167 | SEG30 | 2708.65 | 751.98 | 233 | SEG96 | -2327.15 | 751.98 |  |  |  |  |
| 168 | SEG31 | 2632.35 | 751.98 | 234 | SEG97 | -2403.45 | 751.98 |  |  |  |  |
| 169 | SEG32 | 2556.05 | 751.98 | 235 | SEG98 | -2479.75 | 751.98 |  |  |  |  |
| 170 | SEG33 | 2479.75 | 751.98 | 236 | SEG99 | -2556.05 | 751.98 |  |  |  |  |
| 171 | SEG34 | 2403.45 | 751.98 | 237 | SEG100 | -2632.35 | 751.98 |  |  |  |  |
| 172 | SEG35 | 2327.15 | 751.98 | 238 | SEG101 | -2708.65 | 751.98 |  |  |  |  |
| 173 | SEG36 | 2250.85 | 751.98 | 239 | SEG102 | -2784.95 | 751.98 |  |  |  |  |
| 174 | SEG37 | 2174.55 | 751.98 | 240 | SEG103 | -2861.25 | 751.98 |  |  |  |  |
| 175 | SEG38 | 2098.25 | 751.98 | 241 | SEG104 | -2937.55 | 751.98 |  |  |  |  |
| 176 | SEG39 | 2021.95 | 751.98 | 242 | SEG105 | -3013.85 | 751.98 |  |  |  |  |
| 177 | SEG40 | 1945.65 | 751.98 | 243 | SEG106 | -3090.15 | 751.98 |  |  |  |  |
| 178 | SEG41 | 1869.35 | 751.98 | 244 | SEG107 | -3166.45 | 751.98 |  |  |  |  |
| 179 | SEG42 | 1793.05 | 751.98 | 245 | SEG108 | -3242.75 | 751.98 |  |  |  |  |
| 180 | SEG43 | 1716.75 | 751.98 | 246 | SEG109 | -3319.05 | 751.98 |  |  |  |  |
| 181 | SEG44 | 1640.45 | 751.98 | 247 | SEG110 | -3395.35 | 751.98 |  |  |  |  |
| 182 | SEG45 | 1564.15 | 751.98 | 248 | SEG111 | -3471.65 | 751.98 |  |  |  |  |
| 183 | SEG46 | 1487.85 | 751.98 | 249 | SEG112 | -3547.95 | 751.98 |  |  |  |  |
| 184 | SEG47 | 1411.55 | 751.98 | 250 | SEG113 | -3624.25 | 751.98 |  |  |  |  |
| 185 | SEG48 | 1335.25 | 751.98 | 251 | SEG114 | -3700.55 | 751.98 |  |  |  |  |
| 186 | SEG49 | 1258.95 | 751.98 | 252 | SEG115 | -3776.85 | 751.98 |  |  |  |  |
| 187 | SEG50 | 1182.65 | 751.98 | 253 | SEG116 | -3853.15 | 751.98 |  |  |  |  |
| 188 | SEG51 | 1106.35 | 751.98 | 254 | SEG117 | -3929.45 | 751.98 |  |  |  |  |
| 189 | SEG52 | 1030.05 | 751.98 | 255 | SEG118 | -4005.75 | 751.98 |  |  |  |  |
| 190 | SEG53 | 953.75 | 751.98 | 256 | SEG119 | -4082.05 | 751.98 |  |  |  |  |
| 191 | SEG54 | 877.45 | 751.98 | 257 | SEG120 | -4158.35 | 751.98 |  |  |  |  |
| 192 | SEG55 | 801.15 | 751.98 | 258 | SEG121 | -4234.65 | 751.98 |  |  |  |  |
| 193 | SEG56 | 724.85 | 751.98 | 259 | SEG122 | -4310.95 | 751.98 |  |  |  |  |
| 194 | SEG57 | 648.55 | 751.98 | 260 | SEG123 | -4387.25 | 751.98 |  |  |  |  |
| 195 | SEG58 | 572.25 | 751.98 | 261 | SEG124 | -4463.55 | 751.98 |  |  |  |  |
| 196 | SEG59 | 495.95 | 751.98 | 262 | SEG125 | -4539.85 | 751.98 |  |  |  |  |
| 197 | SEG60 | 419.65 | 751.98 | 263 | SEG126 | -4616.15 | 751.98 |  |  |  |  |
| 198 | SEG61 | 343.35 | 751.98 | 264 | SEG127 | -4692.45 | 751.98 |  |  |  |  |
| 199 | SEG62 | 267.05 | 751.98 | 265 | SEG128 | -4768.75 | 751.98 |  |  |  |  |
| 200 | SEG63 | 190.75 | 751.98 | 266 | SEG129 | -4845.05 | 751.98 |  |  |  |  |
| 201 | SEG64 | 114.45 | 751.98 | 267 | SEG130 | -4921.35 | 751.98 |  |  |  |  |
| 202 | SEG65 | 38.15 | 751.98 | 268 | SEG131 | -4997.65 | 751.98 |  |  |  |  |

## PIN DESCRIPTIONS

## MSTAT

This pin is the static indicator driving output. It is only active in master operation. The frame signal output pin, $M$, should be used as the back plane signal for the static indicator.

The duration of overlapping could be programmable. See Extended Command Table for details.

This pin becomes high impedance if the chip is operating in slave mode.

## M

This pin is the frame signal input/output. In master mode, the pin supplies frame signal to slave devices while in slave mode, the pin receives frame signal from the master device.

## CL

This pin is the display clock input/output. In master mode with internal oscillator enabled (CLS pin pulled high), this pin supplies display clock signal to slave devices.

In slave mode or when internal oscillator is disabled, the pin receives display clock signal from the master device or external clock source.

## $\overline{\text { DOF }}$

This pin is display blanking control between master and slave devices. In master mode, this pin supplies on/off signal to slave devices. In slave mode, this pin receives on/off signal from the master device.

## $\overline{\text { CS1 }}, \mathbf{C S} 2$

These pins are the chip select inputs. The chip is enabled for MCU communication only when both $\overline{\mathrm{CS} 1}$ is pulled low and CS2 is pulled high.

## $\overline{\text { RES }}$

This pin is reset signal input. Initialization of the chip is started once this pin is pulled low. Minimum pulse width for completing the reset procedure is 5us.

## D/ $\bar{C}$

This pin is Data/Command control pin. When the pin is pulled high, the data at $D_{7}-D_{0}$ is treated as display data. When the pin is pulled low, the data at $\mathrm{D}_{7}-\mathrm{D}_{0}$ will be transferred to the command register. Details relationship with other MCU interface signals, please refer to the Timing Characteristics Diagrams.

## $\mathbf{R} / \overline{\mathrm{W}}(\overline{\mathrm{WR}})$

This pin is MCU interface input. When interfacing to an 6800 -series microprocessor, this pin will be used as Read/Write $(R / \bar{W})$ selection input. Read mode will be carried out when this pin is pulled high and write mode when low.

When interfacing to an 8080-microprocessor, this pin will be the Write $\overline{\mathrm{WR})}$ input. Data write operation is initiated when this pin is pulled low when the chip is selected.
$E(\overline{R D})$
This pin is MCU interface input. When interfacing to an 6800 -series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled high when the chip is selected.

When connecting to an 8080-microprocessor, this pin receives the Read $\overline{\mathrm{RD}})$ signal. Data read operation is initiated when this pin is pulled low when the chip is selected.

## $D_{7}-D_{0}$

These pins are the 8-bit bi-directional data bus to be connected to the MCU in parallel interface mode. $D_{7}$ is the MSB while $D_{0}$ is the LSB.

When serial mode is selected, $D_{7}$ is the serial data input (SDA) and $D_{6}$ is the serial clock input (SCK).

## $V_{D D}$

Chip's Power Supply pin. This is also the reference for the DC-DC Converter output and LCD driving voltages.
$\mathrm{V}_{\mathrm{SS}}$
Ground. A reference for the logic pins.

## $\mathrm{V}_{\mathrm{SS} 1}$

Input for internal DC-DC converter. The voltage of generated, $\mathrm{V}_{\mathrm{EE}}$, equals to the multiple factor times the potential different between this pin, $\mathrm{V}_{\mathrm{SS} 1}$, and $\mathrm{V}_{\mathrm{DD}}$. The multiple factor, $2 \mathrm{X}, 3 \mathrm{X}$ or 4 X , is selected by different connections of the external capacitors. All voltage levels are referenced to $\mathrm{V}_{\mathrm{DD}}$.

Note: the potential at this input pin must lower than or equal to $V_{S S}$.
$\mathrm{V}_{\mathrm{EE}}$
This is the most negative voltage supply pin of the chip. It can be supplied externally or generated by the internal DC-DC converter, by turning on the internal voltage booster option in the Set Power Control Register command.

When using internal DC-DC converter as generator, voltage at this pin is for internal reference only. It CANNOT be used for driving external circuitries.

## $\mathrm{C}_{3 \mathrm{~N}}, \mathrm{C}_{1 \mathrm{P}}, \mathrm{C}_{1 \mathrm{~N}}, \mathrm{C}_{2 \mathrm{~N}}$ and $\mathrm{C}_{2 \mathrm{P}}$

When internal DC-DC voltage converter is used, external capacitor(s) is/are connected between these pins. Different connection will result in different DC-DC converter multiple factor, $2 \mathrm{X}, 3 \mathrm{X}$ or 4 X . Detail connections please refer to voltage converter section in the functional block description.

## $V_{F S}$

This is an input pin to provide an external voltage reference for the internal voltage regulator. The function of this pin is only enabled for the External Input chip models which are required special ordering. For normal chip model, please leave this pin NC (No connection).

## $\mathrm{V}_{\mathrm{L} 2}, \mathrm{~V}_{\mathrm{L} 3}, \mathrm{~V}_{\mathrm{L} 4}$ and $\mathrm{V}_{\mathrm{L} 5}$

These are the LCD driving voltage levels. All these levels are referenced to $\mathrm{V}_{\mathrm{DD}}$.

They can be supplied externally or generated by the internal bias divider, by turning on the output op-amp buffersoption in the Set Power Control Register command.

The potential relation of these pins are given as:
$V_{D D}>V_{L 2}>V_{L 3}>V_{L 4}>V_{L 5}>V_{L 6}$
and with bias factor, a,

$$
\begin{aligned}
V_{L 2}-V_{D D} & =1 / a *\left(V_{L 6}-V_{D D}\right) \\
V_{L 3}-V_{D D} & =2 / a *\left(V_{L 6}-V_{D D}\right) \\
V_{L 4}-V_{D D} & =(a-2) / a *\left(V_{L 6}-V_{D D}\right) \\
V_{L 5}-V_{D D} & =(a-1) / a *\left(V_{L 6}-V_{D D}\right)
\end{aligned}
$$

$\mathrm{V}_{\mathrm{L}}$
This pin is the most negative LCD driving voltage. It can be supplied externally or generated by turning on the internal regulator option in the Set Power Control Register command.

## $V_{F}$

This pin is the input of the built-in voltage regulator for generating $\mathrm{V}_{\mathrm{L} 6}$.

When external resistor network is selected (IRS pulled low) to generate the LCD driving level, $\mathrm{V}_{\mathrm{L} 6}$, two external resistors, $\mathrm{R}_{1}$ and $R_{2}$, should be connected between $V_{D D}$ and $V_{F}$, and $V_{F}$ and $\mathrm{V}_{\mathrm{L} 6}$, respectively (see application circuit diagrams).

## M/S

This pin is the master/slave mode selection input. When this pin is pulled high, master mode is selected, which CL, M, MSTAT and DOF signals will be output for slave devices.

When this pin is pulled low, slave mode is selected, which $C L, M, \overline{D O F}$ are required to be input from master device and MSTAT is high impedance.

## CLS

This pin is the internal clock enable pin. When this pin is pulled high, internal clock is enabled.

The internal clock will be disabled when it is pulled low, an external clock source must be input to CL pin for normal operation.

## C68/80

This pin is MCU parallel interface selection input. When the pin is pulled high, 6800 series interface is selected and when the pin is pulled low, 8080 series interface is selected.

If Serial Interface is selected ( $\mathrm{P} / \overline{\mathrm{S}}$ pulled low), the setting of this pin is ignored, but must be connected to a known logic (either high or low).

## $\mathbf{P} / \overline{\mathbf{S}}$

This pin is serial/parallel interface selection input. When this pin is pulled high, parallel interface mode is selected. When it is pulled low, serial interface will be selected.

Note1: For serial mode, D0, D1, D2, D3, D4, D5, R/W/ (WR), $\mathrm{E} /(\mathrm{RD})$ is recommended to be connected to Vss.

Note2: Read Back operation is only available in parallel mode.

## HPM

This pin is the control input of High Power Current Mode. The function of this pin is only enabled for High Power model which required special ordering.

For normal models, High Power Mode is disabled and the LCD driving characteristics are the same no matter this pin is pulled High or Low.

Note: This pin must be pulled to either High or Low. Leaving this pin floating is prohibited.

## IRS

This is the input pin to enable the internal resistors network for the voltage regulator. When this pin is pulled high, the internal feedback resistors of the internal regulator for generating $\mathrm{V}_{\mathrm{L} 6}$ will be enabled.

When it is pulled low, external resistors, $R_{1}$ and $R_{2}$, should be connected to $\mathrm{V}_{\mathrm{DD}}$ and $\mathrm{V}_{\mathrm{F}}$, and $\mathrm{V}_{\mathrm{F}}$ and $\mathrm{V}_{\mathrm{L6}}$, respectively (see application circuit diagrams).

## ROW0 - ROW63

These pins provide the Common driving signals to the LCD panel. See Table 3 on page 10 for the COM signal mapping in SSD1815B.

## SEG0 - SEG131

These pins provide the LCD segment driving signals. The output voltage level of these pins is $\mathrm{V}_{\mathrm{DD}}$ during sleep mode and standby mode.

## ICONS

There are two ICONS pins (pin12 and 136) on the chip. Both pins output exactly the same signal. The reason for duplicating the pin is to enhance the flexibility of the LCD layout.

## NC

These are the No Connection pins. Nothing should be connected to these pins, nor they are connected together. These pins should be left open individually.

Table 3 ROW pin assignments for COM signals for SSD1815B .

| Die Pad Name | SSD1815B |
| :---: | :---: |
| ROW0 | COM0 |
| ROW1 | COM1 |
| ROW2 | COM2 |
| ROW3 | COM3 |
| ROW4 | COM4 |
| ROW5 | COM5 |
| ROW6 | COM6 |
| ROW7 | COM7 |
| ROW8 | COM8 |
| ROW9 | COM9 |
| ROW10 | COM10 |
| ROW11 | COM11 |
| ROW12 | COM12 |
| ROW13 | COM13 |
| ROW14 | COM14 |
| ROW15 | COM15 |
| ROW16 | COM16 |
| ROW17 | COM17 |
| ROW18 | COM18 |
| ROW19 | COM19 |
| ROW20 | COM20 |
| ROW21 | COM21 |
| ROW22 | COM22 |
| ROW23 | COM23 |
| ROW24 | COM24 |
| ROW25 | COM25 |
| ROW26 | COM26 |
| ROW27 | COM27 |
| ROW28 | COM28 |
| ROW29 | COM29 |
| ROW30 | COM30 |
| ROW31 | COM31 |
| ROW32 | COM32 |
| ROW33 | COM33 |
| ROW34 | COM34 |
| ROW35 | COM35 |
| ROW36 | COM36 |
| ROW37 | COM37 |
| ROW38 | COM38 |
| ROW39 | COM39 |
| ROW40 | COM40 |
| ROW41 | COM41 |
| ROW42 | COM42 |
| ROW43 | COM43 |
| ROW44 | COM44 |
| ROW45 | COM45 |
| ROW46 | COM46 |
| ROW47 | COM47 |
| ROW48 | COM48 |
| ROW49 | COM49 |
| ROW50 | COM50 |
| ROW51 | COM51 |
| ROW52 | COM52 |
| ROW53 | COM53 |
| ROW54 | COM54 |
| ROW55 | COM55 |
| ROW56 | COM56 |
| ROW57 | COM57 |
| ROW58 | COM58 |
| ROW59 | COM59 |
| ROW60 | COM60 |
| ROW61 | COM61 |
| ROW62 | COM62 |
| ROW63 | COM63 |

## FUNCTIONAL BLOCK DESCRIPTIONS

## Command Decoder and Command Interface

This module determines whether the input data is interpreted as data or command. Data is directed to this module based upon the input of the $\mathrm{D} / \overline{\mathrm{C}}$ pin.

If $D / \bar{C}$ pin is high, data is written to Graphic Display Data RAM (GDDRAM). If it low, the input at $D_{7}-D_{0}$ is interpreted as a Command and it will be decoded and be written to the corresponding command register.

## MPU Parallel 6800-series Interface

The parallel interface consists of 8 bi-directional data pins ( $\left.D_{7}-D_{0}\right), R / \bar{W}(\overline{W R}), D / \bar{C}, E(\overline{R D}), \overline{C S 1}$ and CS2. $R / \bar{W}(\overline{W R})$ input high indicates a read operation from the Graphic Display Data RAM (GDDRAM) or the status register. $\overline{/} \bar{W}(\overline{W R})$ input Low indicates a write operation to Display Data RAM or Internal Command Registers depending on the status of $D / \bar{C}$ input. The $E(\overline{\mathrm{RD}})$ input serves as data latch signal (clock) when high provided that CS1 and CS2 are low and high respectively. Refer to Figure 11 on page 27 for Parallel Interface Timing Diagram of 6800series microprocessors.

In order to match the operating frequency of the GDDRAM with that of the MCU, some pipeline processing is internally performed which requires the insertion of a dummy read before the first actual display data read. This is shown in Figure 3.

## MPU Parallel 8080-series interface

The parallel interface consists of 8 bi-directional data pins ( $\left.D_{7}-D_{0}\right), E(\overline{R D}), R / \bar{W}(\overline{W R}), D / \bar{C}, \overline{\mathrm{CS} 1}$ and CS2. $E(\overline{R D})$ input serves as data read latch signal (clock) when low provided that $\overline{\mathrm{CS} 1}$ and CS2 are low and high respectively. Whether it is display data or status register read is controlled by $\mathrm{D} / \overline{\mathrm{C}} . \mathrm{R} / \overline{\mathrm{W}}(\overline{\mathrm{WR}})$ input serves as data write latch signal(clock) when high provided that $\overline{\mathrm{CS} 1}$ and CS2 are low and high respectively. Whether it is display data or command register write is controlled by D/ $\overline{\mathrm{C}}$. Refer to Figure 12 on page 28 for Parallel Interface Timing Diagram of 8080-series microprocessor.

Similar to 6800-series interface, a dummy read is also required before the first actual display data read.

## MPU Serial interface

The serial interface consists of serial clock $\operatorname{SCK}\left(\mathrm{D}_{6}\right)$, serial data SDA $\left(\mathrm{D}_{7}\right), \mathrm{D} / \overline{\mathrm{C}}, \overline{\mathrm{CS} 1}$ and CS2. SDA is shifted into a 8 -bit shift register on every rising edge of SCK in the order of $D_{7}, D_{6}, \ldots$ $D_{0} . D / \bar{C}$ is sampled on every eighth clock to determine whether the data byte in the shift register is written to the Display Data RAM or command register at the same clock. Refer to Figure 13 on Page28 for Serial Interface Timing Diagram.


Figure 3 Display Data Read Back Procedure - Insertion of Dummy Read

## Oscillator Circuit

This module is an On-Chip low power RC oscillator circuitry (Figure 4). The oscillator generates the clock for the DC-DC voltage converter. This clock is also used in the Display Timing Generator.


Figure 4 Oscillator Circuitry

## LCD Driving Voltage Generator and Regulator

This module generates the LCD voltage required for display driving output. With reference to $\mathrm{V}_{\mathrm{DD}}$, it takes a single supply input, $\mathrm{V}_{\mathrm{SS}}$, and generate necessary voltage levels. This block consists of:

## 1. 2X, 3X and 4X DC-DC voltage converter

The built-in DC-DC voltage converter is used to generate the large negative voltage supply with reference to VDD from the voltage input (VSS1). SSD1815B is possible to produce $2 \mathrm{X}, 3 \mathrm{X}$ or 4 X boosting from the potential different between $\mathrm{V}_{\mathrm{SS} 1}-\mathrm{V}_{\mathrm{DD}}$.

Detail configurations of the DC-DC converter for different boosting multiples are given in Figure 5.
2. Voltage Regulator (Voltages referenced to $\mathrm{V}_{\mathrm{DD}}$ )

The feedback gain control for LCD driving contrast curves can be selected by IRS pin to either internal (IRS pin $=\mathrm{H}$ ) or external (IRS pin = L).

If internal resistor network is enabled, eight settings can be selected through software command.

If external control is selected, external resistors are required to be connected between $V_{D D}$ and $V_{F}(R 1)$, and between $V_{F}$ and $V_{L 6}(R 2)$. See application circuit diagrams for detail connections.


Figure 5 DC-DC Converter Configurations
3. Contrast Control (Voltages referenced to $\mathrm{V}_{\mathrm{DD}}$ )

Software control of the 64 contrast voltage levels at each voltage regulator feedback gain. The equation of calculating the LCD driving voltage is given as:

|  | $\begin{aligned} & V_{L 6}-V_{D D}=\operatorname{Gain} *\left(1+\frac{\text { Contrast }}{\beta}\right) * V_{r e f} \\ & V_{r e f}=\left(\frac{V_{B E}+R *\left(V_{D D}-V_{S S}\right)}{1+R}\right) \end{aligned}$ |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| where |  |  |  |  |  |  |  |  |  |  |
| Int. Reg. <br> Resistor <br> Ratio Setting | 0 | 1 |  | 2 | 3 | 4 | 5 | 6 | 7 | Ext. <br> Resistor |
| Gain | -3.37 |  | . 87 | -4.43 | -4.99 | -5.58 | -6.00 | -6.67 | -7.27 | $-\left(1+R_{2} / R_{1}\right)$ |
| Beta | 96.79 |  | .53 | 96.33 | 96.06 | 95.78 | 95.54 | 95.26 | 95.02 | 97.62 |
|  |  | TC |  | ${ }^{\circ} \mathrm{C}$ ) | $\begin{gathered} 2 \\ \left(-0.15 \% /{ }^{\circ} \mathrm{C}\right) \\ \hline \end{gathered}$ | $\begin{gathered} \hline 4 \\ \left(-0.20 \% /{ }^{\circ}\right. \\ \hline \end{gathered}$ | $(-0.30$ |  |  |  |
|  |  | VBE |  |  | 0.52 | 0.52 |  |  |  |  |
|  |  | R |  |  | 0.43 | 0.27 |  |  |  |  |



Figure 6 Voltage Regulator Output for Different Gain/Contrast Settings

## 4. Bias Divider

If the output op-amp buffer option in Set Power Control Register command is enabled, this circuit block will divide the regulator output $\left(\mathrm{V}_{\mathrm{L6}}\right)$ to give the LCD driving levels $\left(\mathrm{V}_{\mathrm{L} 2}-\mathrm{V}_{\mathrm{L}}\right)$.

A low power consumption circuit design in this bias divider saves most of the display current comparing to traditional design.

Stablizing Capacitors (0.01~0.47uF) are required to be connected between these voltage level pins $\left(\mathrm{V}_{\mathrm{L} 2}-\mathrm{V}_{\mathrm{L} 5}\right)$ and $\mathrm{V}_{\mathrm{DD}}$. If the LCD panel loading is heavy, four additional resistors are suggested to add to the application circuit as follows:


Figure 7 Connections for heavy loading applications

## 5. Bias Ratio Selection circuitry

SSD1815B can be software selected one of the bias ratios from $1 / 4,1 / 5,1 / 6,1 / 7,1 / 8$ and $1 / 9$.

Since there will be slightly different in command pattern for different members, please refer to Command Descriptions section of this data sheet.

## 6. Self adjust temperature compensation circuitry

This block provides 4 different compensation settings to satisfy various liquid crystal temperature grades by software control. Default temperature coefficient (TC) setting is TCO.

## Graphic Display Data RAM (GDDRAM)

The GDDRAM is a bit mapped static RAM holding the bit pattern to be displayed. The size of the RAM is $132 \times 65=8580$ bits. Figure 8 on page 15 is a description of the GDDRAM address map.

For mechanical flexibility, re-mapping on both Segment and Common outputs can be selected by software.

For vertical scrolling of the display, an internal register storing display start line can be set to control the portion of the RAM data to be mapped to the display. Figure 8 on page 15 shows the case in which the display start line register is set to 38 h .

For those GDDRAM out of the display common range, they could still be accessed, for either preparation of vertical scrolling data or even for the system usage.

## Reset Circuit

This block includes Power On Reset circuitry and the hardware reset pin, RES. Both of these having the same reset function. Once RES receives a negative reset pulse, all internal circuitry will start to initialize. Minimum pulse width for completing the reset sequence is 5us. Status of the chip after reset is
given by:

- Display is turned OFF
- Default Display Display Mode, $132 \times 64$ + 1 Icon Line
- Normal segment and display data column address mapping (Seg0 mapped to Row address 00h)
- Read-modify-write mode is OFF
- Power control register is set to 000b
- Shift register data clear in serial interface
- Bias ratio is set to default, $1 / 9$
- Static indicator is turned OFF
- Display start line is set to GDDRAM column 0
- Column address counter is set to 00 h
- Page address is set to 0
- Normal scan direction of the COM outputs
- Contrast control register is set to 20 h
- Test mode is turned OFF
- Temperature Coefficient is set to TC0

Note: Please find more explanation in the Applications Note attached at the back of the specification.

## Display Data Latch

This block is a series of latches carrying the display signal information. These latches hold the data, which will be fed to the HV Buffer Cell and Level Selector to output the required voltage level.

The numbers of latches are given by: $132+65=197$

## HV Buffer Cell (Level Shifter)

HV Buffer Cell work as a level shifter which translates the low voltage output signal to the required driving voltage. The output is shifted out with an internal FRM clock which comes from the Display Timing Generator. The voltage levels are given by the level selector which is synchronized with the internal M signal.

## Level Selector

Level Selector is a control of the display synchronization. Display voltage levels can be separated into two sets and used with different cycles. Synchronization is important since it selects the required LCD voltage level to the HV Buffer Cell, which in turn outputs the COM or SEG LCD waveform.

## LCD Panel Driving Waveform

Figure 9 on page 16 is an example of how the Common and Segment drivers may be connected to a LCD panel. The waveforms provided illustrates the desired multiplex scheme.


Figure 8 Graphic Display Data RAM (GDDRAM) Address Map with Display Start Line set to 38 h .


Figure 9 LCD Driving Waveform for Displaying " 0 "

## COMMAND TABLE

Table 4 Write Command Table ( $\mathrm{D} / \overline{\mathrm{C}}=0, \mathrm{R} \overline{\mathrm{W}}(\overline{\mathrm{WR}})=0, \mathrm{E}(\overline{\mathrm{RD}})=1$ )

| Bit Pattern | Command | Description |
| :---: | :---: | :---: |
| $0000 X_{3} X_{2} X_{1} \mathrm{X}_{0}$ | Set Lower Column Address | Set the lower nibble of the column address register using $X_{3} X_{2} X_{1} X_{0}$ as data bits. The lower nibble of column address register is reset to 0000 b after POR. |
| $0001 X_{3} X_{2} X_{1} X_{0}$ | Set Higher Column Address | Set the higher nibble of the column address register using $X_{3} X_{2} X_{1} X_{0}$ as data bits. The higher nibble of column address is reset to 0000b after POR. |
| 00100 $\mathrm{X}_{2} \mathrm{X}_{1} \mathrm{X}_{0}$ | Set Internal Regulator Resistor Ratio | Feedback gain of the internal regulator generating $\mathrm{V}_{\mathrm{L} 6}$ increases as $\mathrm{X}_{2} \mathrm{X}_{1} \mathrm{X}_{0}$ increased from 000b to 111b. <br> After POR, $\mathrm{X}_{2} \mathrm{X}_{1} \mathrm{X}_{0}=100 \mathrm{~b}$. |
| 00101 $\mathrm{X}_{2} \mathrm{X}_{1} \mathrm{X}_{0}$ | Set Power Control Register | $\mathrm{X}_{0}=0$ : turns off the output op-amp buffer (POR) <br> $X_{0}=1$ : turns on the output op-amp buffer <br> $X_{1}=0$ : turns off the internal regulator (POR) <br> $X_{1}=1$ : turns on the internal regulator <br> $X_{2}=0$ : turns off the internal voltage booster (POR) <br> $X_{2}=1$ : turns on the internal voltage booster |
| $01 X_{5} X_{4} \mathrm{X}_{3} \mathrm{X}_{2} \mathrm{X}_{1} \mathrm{X}_{0}$ | Set Display Start Line | Set GDDRAM display start line register from 0-63 using $X_{5} X_{4} X_{3} X_{2} X_{1} X_{0}$. Display start line register is reset to 000000 after POR. |
| $\begin{aligned} & 10000001 \\ & { }^{* *} X_{5} X_{4} X_{3} X_{2} X_{1} X_{0} \end{aligned}$ | Set Contrast Control Register | Select contrast level from 64 contrast steps. Contrast increases $\left(\mathrm{V}_{\mathrm{L} 6}\right.$ decreases) as $X_{5} X_{4} X_{3} X_{2} X_{1} X_{0}$ is increased from 000000b to 111111b. $X_{5} X_{4} X_{3} X_{2} X_{1} X_{0}=100000 \mathrm{~b}$ after POR |
| $1010000 X_{0}$ | Set Segment Re-map | $\mathrm{X}_{0}=0$ : column address 00 h is mapped to SEGO (POR) <br> $X_{0}=1$ : column address 83 h is mapped to SEG0 <br> Refer to Figure 8 on page 15 for example. |
| $1010001 X_{0}$ | Set LCD Bias | $\mathrm{X}_{0}=0$ : POR default bias: $1 / 9$ <br> $X_{0}=1$ : alternate bias: $1 / 7$ <br> For other bias ratio settings, see "Set $1 / 4$ Bias Ratio" and "Set Bias Ratio" in Extended Command Set. |
| $1010010 X_{0}$ | Set Entire Display On/Off | $\mathrm{X}_{0}=0$ : normal display (POR) <br> $X_{0}=1$ : entire display on |
| $1010011 X_{0}$ | Set Normal/Reverse Display | $\mathrm{X}_{0}=0$ : normal display (POR) <br> $X_{0}=1$ : reverse display |
| ${1010111 X_{0}}$ | Set Display On/Off | $X_{0}=0$ : turns off LCD panel (POR) <br> $X_{0}=1$ : turns on LCD panel |
| $1011 \mathrm{X}_{3} \mathrm{X}_{2} \mathrm{X}_{1} \mathrm{X}_{0}$ | Set Page Address | Set GDDRAM Page Address (0-8) for read/write using $\mathrm{X}_{3} \mathrm{X}_{2} \mathrm{X}_{1} \mathrm{X}_{0}$ |
| $1100 X_{3}^{* * *}$ | Set COM Output Scan Direction | $X_{3}=0$ : normal mode (POR) <br> $X_{3}=1$ : remapped mode, COM0 to COM[N-1] becomes COM[N-1] to COM0 when Multiplex ratio is equal to N . <br> See Figure 8 on page 15 for detail mapping. |
| 11100000 | Set Read-Modify-Write Mode | Read-Modify-Write mode will be entered in which the column address will not be increased during display data read. After POR, Read-modify-write mode is turned OFF. |
| 11100010 | Software Reset | Initialize internal status registers. |
| 11101110 | Set End of Read-Modify-Write Mode | Exit Read-Modify-Write mode. RAM Column address before entering the mode will be restored. After POR, Read-modify-write mode is OFF. |

Table 4 Write Command Table ( $D / \bar{C}=0, R \bar{W}(\overline{W R})=0, E(\overline{R D})=1)$

| $1010110 X_{0}$ | Set Indicator On/Off | $X_{0}=0:$ indicator off (POR, second command byte is not required) <br> $X_{0}=1:$ indicator on (second command byte required) |
| :--- | :--- | :--- |
|  | Indicator Display Mode, <br> This second byte command is <br> required ONLY when "Set Indicator <br> On" command is sent. | $X_{1} x_{0}=00:$ indicator off <br> $X_{1} X_{0}=01:$ indicator on and blinking at $\sim 1$ second interval <br> $X_{1} X_{0}=10:$ indicator on and blinking at $\sim 1 / 2$ second interval <br> $X_{1} X_{0}=11$ : indicator on constantly |
| 11100011 | NOP | Command result in No Operation |
| 11110000 | Test Mode Reset | Reserved for IC testing. Do NOT use. |
| $1111 * * * *$ | Set Test Mode | Reserved for IC testing. Do NOT use. |
| $* * * * * * * *$ | Set Power Save Mode <br> (Standby or Sleep) | Standby or sleep mode will be entered using compound commands. <br> Issue compound commands "Set Display Off" followed by "Set Entire Display <br> On". |

Table 5 Extended Command Table

| Bit Pattern | Command | Description |
| :---: | :---: | :---: |
| $\begin{aligned} & 10101000 \\ & 00 x_{5} x_{4} x_{3} x_{2} x_{1} x_{0} \end{aligned}$ | Set Multiplex Ratio | To select multiplex ratio N from 2 to the maximum multiplex ratio (POR value) for each member (including icon line). <br> Max. mux ratio: 65 $N=X_{5} X_{4} X_{3} X_{2} X_{1} X_{0}+2, \text { eg. } N=001111 b+2=17$ |
| $\begin{aligned} & 10101001 \\ & x_{7} x_{6} x_{5} x_{4} x_{3} x_{2} x_{1} x_{0} \end{aligned}$ | Set Bias Ratio ( $\mathrm{X}_{1} \mathrm{X}_{0}$ ) <br> Set TC Value $\left(X_{4} X_{3} X_{2}\right)$ <br> Modify Osc. Freq. $\left(\mathrm{X}_{7} \mathrm{X}_{6} \mathrm{X}_{5}\right)$ | Increase the value of $X_{7} X_{6} X_{5}$ will increase the oscillator frequency and vice versa. <br> Default Mode: <br> $\mathrm{X}_{7} \mathrm{X}_{6} \mathrm{X}_{5}=011$ (POR for SSD1815B) : Typ. 19kHz <br> High Frequency Mode: <br> $\mathrm{X}_{7} \mathrm{X}_{6} \mathrm{X}_{5}=110$ (For SSD1815B) : Typ. 23kHz |
| 1010101X 0 | Set 1/4 Bias Ratio | $\begin{aligned} & X_{0}=0 \text { : use normal setting (POR) } \\ & X_{0}=1 \text { : fixed at } 1 / 4 \text { bias } \end{aligned}$ |
| $\begin{aligned} & 11010100 \\ & 00 X_{5} \mathrm{X}_{4} 0000 \end{aligned}$ | Set Total Frame Phases | The On/Off of the Static Icon is given by 3 phases/1 phase overlapping of the M and MSTAT signals. This command set total phases of the M/MSTAT signals for each frame. <br> The more the total phases, the less the overlapping time and thus the lower the effective driving voltage. <br> $\mathrm{X}_{5} \mathrm{X}_{4}=00$ : 3 phases <br> $X_{5} X_{4}=01: 5$ phases <br> $X_{5} X_{4}=10: 7$ phases (POR) <br> $X_{5} X_{4}=11: 16$ phases |
| $\begin{aligned} & 11010011 \\ & 00 x_{5} x_{4} x_{3} x_{2} x_{1} x_{0} \end{aligned}$ | Set Display Offset | After POR, $\mathrm{X}_{5} \mathrm{x}_{4} \mathrm{X}_{3} \mathrm{x}_{2} \mathrm{x}_{1} \mathrm{X}_{0}=0$ <br> After setting mux ratio less than default value, data will be displayed at Center of matrix. <br> To move display towards Row 0 by $L, X_{5} X_{4} X_{3} X_{2} X_{1} X_{0}=L$ <br> To move display away from Row 0 by $\mathrm{L}, \mathrm{X}_{5} \mathrm{X}_{4} \mathrm{X}_{3} \mathrm{X}_{2} \mathrm{X}_{1} \mathrm{X}_{0}=64-\mathrm{L}$ <br> Note: max. value of $\mathrm{L}=(\mathrm{POR}$ default mux ratio - display mux $) / 2$ |

Table 6 Read Command Table ( $\mathrm{D} / \overline{\mathrm{C}}=0, \mathrm{R} / \overline{\mathrm{W}}(\overline{\mathrm{WR}})=1, \mathrm{E}=1(\overline{\mathrm{RD}}=0)$ )

| Bit Pattern | Command | Description |
| :---: | :---: | :---: |
| $\mathrm{D}_{7} \mathrm{D}_{6} \mathrm{D}_{5} \mathrm{D}_{4} \mathrm{D}_{3} \mathrm{D}_{2} \mathrm{D}_{1} \mathrm{D}_{0}$ | Status Register Read | $D_{7}=0$ : indicates the driver is ready for command. <br> $\mathrm{D}_{7}=1$ : indicates the driver is Busy. <br> $D_{6}=0$ : indicates reverse segment mapping with column address. <br> $D_{6}=1$ : indicates normal segment mapping with column address. <br> $D_{5}=0$ : indicates the display is $O N$. <br> $\mathrm{D}_{5}=1$ : indicates the display is OFF. <br> $\mathrm{D}_{4}=0$ : initialization is completed. <br> $D_{4}=1$ : initialization process is in progress after $\overline{R E S}$ or software reset. <br> $D_{3} D_{2} D_{1} D_{0}=0010$, these 4-bit is fixed to 0010 which could be used to identify as Solomon Systech Device. |

Note: Patterns other than that given in Command Table and Extended Command Table are prohibited to enter to the chip as a command. Otherwise, unexpected result will occurs.

## Data Read / Write

To read data from the GDDRAM, input High to R/ $\overline{\mathrm{W}}(\overline{\mathrm{WR}})$ pin and $\mathrm{D} / \overline{\mathrm{C}}$ pin for 6800-series parallel mode, Low to $\mathrm{E}(\overline{\mathrm{RD}})$ pin and High to $D / \bar{C}$ pin for 8080 -series parallel mode. No data read is provided in serial interface mode.

In normal data read mode, GDDRAM column address pointer will be increased by one automatically after each data read. However, no automatic increase will be performed in read-modify-write mode.

Also, a dummy read is required before first valid data is read. See Figure 3 on page 11 in Functional Block Descriptions section for detail waveform diagram.

To write data to the GDDRAM, input Low to $\mathrm{R} \overline{\bar{W}}(\overline{\mathrm{WR}})$ pin and High to $\mathrm{D} / \overline{\mathrm{C}}$ pin for both 6800 -series and 8080 -series parallel mode. For serial interface mode, it is always in write mode. GDDRAM column address pointer will be increased by one automatically after each data write.

It should be noted that, after the automatic column address increment, the pointer will NOT wrap round to 0 when overflow (>131). The incrementation of the pointer stops at 131. Therefore there is a need to re-initialize the pointer when progress to another page address.

Table 7 Automatic Address Increment

| $\mathbf{D} / \overline{\mathbf{C}}$ | $\mathbf{R} / \overline{\mathbf{W}}(\overline{\mathbf{W R}})$ | Action | Auto Address <br> Increment |
| :---: | :---: | :---: | :---: |
| 0 | 0 | Write Command | No |
| 0 | 1 | Read Status | No |
| 1 | 0 | Write Data | Yes |
| 1 | 1 | Read Data | Yes $^{* 1}$ |

*1. If read data is issued in read-modify-write mode, address will not be increased automatically.

## COMMAND DESCRIPTIONS

## Set Lower Column Address

This command specifies the lower nibble of the 8-bit column address of the display data RAM. The column address will be increased by each data access after it is pre-set by the MCU.

## Set Higher Column Address

This command specifies the higher nibble of the 8 -bit column address of the display data RAM. The column address will be increased by each data access after it is pre-set by the MCU.

## Set Internal Regulator Resistors Ratio

This command is to enable any one of the eight internal resistor sets for different regulator gain when using internal regulator resistor network (IRS pin pulled high). In other words, this command is used to select which contrast curve from the eight possible selections. Please refer to Functional Block Descriptions section for detail calculation of the LCD driving voltage.

## Set Power Control Register

This command turns on/off the various power circuits associated with the chip. There are three power relating sub-circuits could be turned on/off by this command.

Internal voltage booster is used to generated the large negative voltage supply $\left(\mathrm{V}_{\mathrm{EE}}\right)$ from the voltage input $\left(\mathrm{V}_{\mathrm{SS} 1}-\mathrm{V}_{\mathrm{DD}}\right)$. An external negative power supply is required if this option is turned off.

Internal regulator is used to generate the LCD driving voltage. $\mathrm{V}_{\mathrm{L} 6}$, from the negative power supply, $\mathrm{V}_{\mathrm{EE}}$.

Output op-amp buffer is the internal divider for dividing the different voltage levels $\left(\mathrm{V}_{\mathrm{L} 2}, \mathrm{~V}_{\mathrm{L} 3}, \mathrm{~V}_{\mathrm{L} 4}, \mathrm{~V}_{\mathrm{L} 5}\right)$ from the internal regulator output, $\mathrm{V}_{\mathrm{L} 6}$. External voltage sources should be fed into this driver if this circuit is turned off.

## Set Display Start Line

This command is to set Display Start Line register to determine starting address of display RAM to be displayed by selecting a value from 0 to 63 . With value equals to 0 , D0 of Page 0 is mapped to COM0. With value equals to 1, D1 of Page0 is mapped to COMO and so on. Display start line values of 0 to 63 are assigned to Page 0 to 7 .

Please refer to Figure 8 on page 15 as an example for display start line set to 56 (38h).

## Set Contrast Control Register

This command adjusts the contrast of the LCD panel by changing the LCD drive voltage, $\mathrm{V}_{\mathrm{L} 6}$, provided by the On-Chip power circuits. $\mathrm{V}_{\mathrm{L} 6}$ is set with 64 steps (6-bit) in the contrast control register by a compound commands.

See Figure 10 for the contrast control flow.

## Set Segment Re-map

This command changes the mapping between the display data column addresses and segment drivers. It allows flexibility in mechanical layout of LCD glass design. Please refer to Figure 8 on page 15 for example.

## Set LCD Bias

This command is used to select a suitable bias ratio required for driving the particular LCD panel in use.

The selectable values of this command are $1 / 9$ or $1 / 7$.
For other bias ratio settings, extended commands should be used.

## Set Entire Display On/Off

This command forces the entire display, including the icon row, to be illuminated regardless of the contents of the GDDRAM. In addition, this command has higher priority than the normal/reverse display.

This command is used together with "Set Display Display ON/OFF" command to form a compound command for entering power save mode. See "Set Power Save Mode" later in this section.

## Set Normal/Reverse Display

This command turns the display to be either normal or reversed. In normal display, a RAM data of 1 indicates an illumination on the corresponding pixel, while in reversed display, a RAM data of 0 will turn on the pixel.

It should be noted that the icon line will not affect, that is not be reversed, by this command.

## Set Display On/Off

This command is used to turn the display on or off. When display off is issued with entire display is on, power save mode will be entered. See "Set Power Save Mode" later in this section for details.

## Set Page Address

This command enters the page address from 0 to 8 to the RAM pager register for read/write operations. Please refer to Figure 8 on page 15 for detail mapping.

## Set COM Output Scan Direction

This command sets the scan direction of the COM output allowing layout flexibility in LCD module assembly. See Figure 8 on page 15 for the relationship between turning on or off of this feature.

In addition, the display will have immediate effect once this command is issued. That is, if this command is sent during normal display, the graphic display will have vertical flipping effect.


Figure 10 Contrast Control Flow

## Set Read-Modify-Write Mode

This command puts the chip in read-modify-write mode in which:

1. column address is saved before entering the mode
2. column address is increased only after display data write but not after display data read.
This Ready-Modify-Write mode is used to save the MCU's loading when a very portion of display area is being updated frequently.

As reading the data will not change the column address, it could be get back from the chip and do some operation in the MCU. Then the updated data could be write back to the GDDRAM with automatic address increment.

After updating the area, "Set End of Read-Modify-Write Mode" is sent to restore the column address and ready for next update sequence.

## Software Reset

Issuing this command causes some of the chip's internal status registers to be initialized:

- Read-Modify-Write mode is exited
- Static indicator is turned OFF
- Display start line register is cleared to 0
- Column address counter is cleared to 0
- Page address is cleared to 0
- Normal scan direction of the COM outputs
- Internal regulator resistors Ratio is set to 4
- Contrast control register is set to 20 h


## Set End of Read-Modify-Write Mode

This command relieves the chip from read-modify-write mode. The column address before entering read-modify-write mode will be restored no matter how much modification during the read-modify-write mode.

## Set Indicator On/Off

This command turns on or off the static indicator driven by the $M$ and MSTAT pins.

When the "Set Indicator On" command is sent, the second command byte "Indicator Display Mode" must be followed. However, the "Set Indicator Off" command is a single byte command and no second byte command is required.

The status of static indicator also controls whether standby mode or sleep mode will be entered, after issuing the power save compound command. See "Set Power Save Mode" later in this section.

## NOP

A command causing the chip takes No OPeration.

## Set Test Mode

This command force the driver chip into its test mode for internal testing of the chip. Under normal operation, users should NOT apply this command.

## Set Power Save Mode

Entering Standby or Sleep Mode should be done by using a compound command composed of "Set Display ON/OFF" and "Set Entire Display ON/OFF" commands. When "Set Entire Display ON" is issued when display is OFF, either Standby Mode or Sleep Mode will be entered.

The status of the Static Indicator will determine which power save mode is entered. If static indicator is off, the Sleep Mode will be entered:

- Internal oscillator and LCD power supply circuits are stopped
- Segment and Common drivers output $\mathrm{V}_{\mathrm{DD}}$ level
- The display data and operation mode before sleep are held
- Internal display RAM can still be accessed

If the static indicator is on, the chip enters Standby Mode which is similar to sleep mode except addition with:

- Internal oscillator is on
- Static drive system is on

Please also be noted that during Standby Mode, if the software reset command is issued, Sleep Mode will be entered. Both power save modes can be exited by the issue of a new software command or by pulling Low at hardware pin RES.

## Status register Read

This command is issued by pulling $\mathrm{D} / \overline{\mathrm{C}}$ Low during a data read (refer to Figure 11 on page 27 and Figure 12 on page 28 for parallel interface waveforms). It allows the MCU to monitor the internal status of the chip.

No status read is provided for serial mode.

## EXTENDED COMMANDS

These commands are used, in addition to basic commands, to trigger the enhanced features designed for the chip.

## Set Multiplex Ratio

This command switches default multiplex ratio to any multiplex mode from 2 to the maximum multiplex ratio (POR value), including the icon line. Max. mux ratio: 65

The chip pins ROW0-ROW63 will be switched to corresponding COM signal output, see Table 8 on page 21 for examples of 18 multiplex (including icon line) settings without and with 7 lines display offset for SSD1815B.

It should be noted that after changing the display multiplex ratio, the bias ratio may also need to be adjusted to make display contrast consistent.

Table 8 Row pin assignments for COM signals in 18 mux display (including icon line) with/without 7 line display offset towards ROWO.

| Die Pad Name | SSD1815B |  |
| :---: | :---: | :---: |
|  | No Offset | 7 lines <br> Offset |
| ROW0 | X | X |
| ROW1 | X | X |
| ROW2 | X | X |
| ROW3 | X | X |
| ROW4 | X | X |
| ROW5 | X | X |
| ROW6 | X | X |
| ROW7 | X | X |
| ROW8 | X | X |
| ROW9 | X | X |
| ROW10 | X | X |
| ROW11 | X | X |
| ROW12 | X | X |
| ROW13 | X | X |
| ROW14 | X | X |
| ROW15 | X | X |
| ROW16 | X | COMO |
| ROW17 | X | COM1 |
| ROW18 | X | COM2 |
| ROW19 | X | COM3 |
| ROW20 | X | COM4 |
| ROW21 | X | COM5 |
| ROW22 | X | COM6 |
| ROW23 | COM0 | COM7 |
| ROW24 | COM1 | COM8 |
| ROW25 | COM2 | COM9 |
| ROW26 | COM3 | COM10 |
| ROW27 | COM4 | COM11 |
| ROW28 | COM5 | COM12 |
| ROW29 | COM6 | COM13 |
| ROW30 | COM7 | COM14 |
| ROW31 | COM8 | COM15 |
| ROW32 | COM9 | COM16 |
| ROW33 | COM10 | X |
| ROW34 | COM11 | X |
| ROW35 | COM12 | X |
| ROW36 | COM13 | X |
| ROW37 | COM14 | X |
| ROW38 | COM15 | X |
| ROW39 | COM16 | X |
| ROW40 | X | X |
| ROW41 | X | X |
| ROW42 | X | X |
| ROW43 | X | X |
| ROW44 | X | X |
| ROW45 | X | X |
| ROW46 | X | X |
| ROW47 | X | X |
| ROW48 | X | X |
| ROW49 | X | X |
| ROW50 | X | X |
| ROW51 | X | X |
| ROW52 | X | X |
| ROW53 | X | X |
| ROW54 | X | X |
| ROW55 | X | X |
| ROW56 | X | X |
| ROW57 | X | X |
| ROW58 | X | X |
| ROW59 | X | X |
| ROW60 | X | X |
| ROW61 | X | X |
| ROW62 | X | X |
| ROW63 | X | X |

Note: X - Row pin will output non-selected COM signal.

## Set Bias Ratio

Except the $1 / 4$ bias, all other available bias ratios could be selected using this command plus the "Set LCD Bias" command. For detail setting values and POR default, please refer to the extended command table, Table 5 on page 18.

## Set Temperature Coefficient (TC) Value

4 different temperature coefficient settings is selected by this command in order to match various liquid crystal temperature grades. Please refer to the extended command table, Table 5 on page 18, for detail TC values.

## Modify Oscillator Frequency

The oscillator frequency can be fine tuned by applying this command. Since the oscillator frequency will be affected by some other factors, this command is not recommended for general usage. Please contact SOLOMON Systech Limited application engineers for more detail explanation on this command.

## Set 1/4 Bias Ratio

This command sets the bias ratio directly to $1 / 4$. This bias ratio is especially designed for use in under 12 mux display.

In order to restore to other bias ratio, this command must be executed, with LSB=0, before the "Set Multiplex ratio" or "Set LCD Bias" command is sent.

## Set Total Frame Phases

The total number of phases for one display frame is set by this command.

The Static Icon is generated by the overlapping of the M and MSTAT signals. These two pins output either $\mathrm{V}_{S S}$ or $\mathrm{V}_{\mathrm{DD}}$ at same frequency but with phase different.

To turn on the Static Icon, 3 phases overlapping is applied to these signals, while 1 phase overlapping is given to the Off status.

The more the total number of phases in one frame, the less the overlapping time and thus the lower the effective driving voltage at the Static Icon on the LCD panel.

## Set Display Offset

This command should be sent ONLY when the multiplex ratio is set less than SSD1815B's default value.

When a lesser multiplex ratio is set, the display will be mapped in the middle ( $y$-direction) of the LCD, see the no offset columns on Table 8 on page 21. Use this command could move the display vertically within the 64 commons.

To make the Reduced-Mux Com 0 (Com 0 after reducing the multiplex ratio) towards the Row 0 direction for $L$ lines, the 6bit data in second command should be given by L. An example for 7 line moving towards to Com0 direction is given on Table 8 on page 21 .

To move in the other direction by $L$ lines, the 6 -bit data should be given by 64-L.

Please note that the display confined within SSD1815B's default multiplex value. That is the maximum value of $L$ is given by the half of the default value minus the reduced-multiplex ratio. For an odd display mux after reduction, moving away from Row 0 direction will has 1 more step.

## MAXIMUM RATINGS

Table 9 Maximum Ratings* (Voltage Reference to $\mathrm{V}_{\mathrm{SS}}$ )

| Symbol | Parameter | Value | Unit |
| :---: | :--- | :---: | :---: |
| $\mathrm{V}_{\mathrm{DD}}$ | Supply Voltage | -0.3 to +4.0 | V |
|  |  | 0 to -12.0 | V |
| $\mathrm{~V}_{\mathrm{EE}}$ |  | $\mathrm{V}_{\mathrm{SS}}-0.3$ to <br> $\mathrm{V}_{\mathrm{DD}}+0.3$ | V |
| $\mathrm{~V}_{\text {in }}$ | Input Voltage | 25 | mA |
| I | Current Drain Per Pin Excluding $\mathrm{V}_{\mathrm{DD}}$ and $\mathrm{V}_{\mathrm{SS}}$ | -30 to +85 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{A}}$ | Operating Temperature | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{Stg}}$ | Storage Temperature Range |  |  |

* Maximum Ratings are those values beyond which damage to the device may occur. Functional operation should be restricted to the limits in the Electrical Characteristics tables or Pin Description section.

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions to be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit. For proper operation it is recommended that $V_{\text {in }}$ and $V_{\text {out }}$ be constrained to the range $\mathrm{V}_{\mathrm{SS}}<$ or $=\left(\mathrm{V}_{\text {in }}\right.$ or $\left.\mathrm{V}_{\text {out }}\right)<$ or $=\mathrm{V}_{\mathrm{DD}}$. Reliability of operation is enhanced if unused input are connected to an appropriate logic voltage level (e.g. either $\mathrm{V}_{S S}$ or $\mathrm{V}_{\mathrm{DD}}$ ). Unused outputs must be left open. This device may be light sensitive. Caution should be taken to avoid exposure of this device to any light source during normal operation. This device is not radiation protected.

## DC CHARACTERISTICS

Table 10 DC Characteristics (Unless otherwise specified, Voltage Referenced to $\mathrm{V}_{\mathrm{SS}}, \mathrm{V}_{\mathrm{DD}}=2.4$ to $3.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-30$ to $85^{\circ} \mathrm{C}$.)

| Symbol | Parameter | Test Condition | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{DD}}$ | Logic Circuit Supply Voltage Range | Recommend Operating Voltage Possible Operating Voltage | $\begin{aligned} & 2.4 \\ & 1.8 \end{aligned}$ | 2.7 | $\begin{aligned} & 3.5 \\ & 3.5 \end{aligned}$ | $\begin{aligned} & \text { V } \\ & \text { V } \end{aligned}$ |
| $\mathrm{I}_{\text {AC }}$ | Access Mode Supply Current Drain ( $V_{\text {DD }}$ Pins) | $\mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}$, Voltage Generator On, 4 X DC-DC Converter Enabled, Write accessing, $T_{\text {cyc }}=3.3 \mathrm{MHz}$, Typ. Osc. Freq., Display On, no panel attached. | - | 300 | 600 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{DP} 1}$ | Display Mode Supply Current Drain ( $V_{\text {DD }}$ Pins) | $\mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-8.1 \mathrm{~V}$, Voltage Generator Disabled, R/W ( $\overline{W R}$ ) Halt, Typ. Osc. Freq., Display On, $\mathrm{V}_{\mathrm{L} 6}-\mathrm{V}_{\mathrm{DD}}=-9 \mathrm{~V}$, no panel attached. | - | 60 | 100 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{DP} 2}$ | Display Mode Supply Current Drain (VDD Pins) | $\mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-8.1 \mathrm{~V}$, Voltage Generator On, 4x DC-DC Converter Enabled, R/ $\bar{W}(\overline{W R})$ Halt, Typ. Osc. Freq., Display On, $V_{L 6}-V_{D D}=-9 \mathrm{~V}$, no panel attached. | - | 150 | 200 | $\mu \mathrm{A}$ |
| $I_{S B}$ | Standby Mode Supply Current Drain ( $V_{\text {DD }}$ Pins) | $\mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}$, LCD Driving Waveform Off, Typ. Osc. Freq., R/ $\bar{W}(\overline{W R})$ halt. | - | 3.5 | 10 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {SLEEP }}$ | Sleep Mode Supply Current Drain (VD Pins) | $\mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}$, LCD Driving Waveform Off, Oscillator Off, R $\bar{N}(\overline{\mathrm{WR}})$ halt. | - | 0.2 | 5 |  |
| $\mathrm{V}_{\mathrm{EE}}$ | LCD Driving Voltage Generator Output ( $\mathrm{V}_{\mathrm{EE}}$ Pin) | Display On, Voltage Generator Enabled, DC-DC Converter Enabled, Typ. Osc. Freq., Regulator Enabled, Divider Enabled. | -12.0 | - | -1.8 | V |
| $\mathrm{V}_{\text {LCD }}$ | LCD Driving Voltage Input ( $\mathrm{V}_{\text {EE }}$ Pin) | Voltage Generator Disabled. | -12.0 | - | -1.8 | V |

Table 10 DC Characteristics (Unless otherwise specified, Voltage Referenced to $\mathrm{V}_{\mathrm{SS}}, \mathrm{V}_{\mathrm{DD}}=2.4$ to $3.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-30$ to $85^{\circ} \mathrm{C}$.)

| Symbol | Parameter | Test Condition | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH} 1}$ | Logic High Output Voltage | $\mathrm{I}_{\text {out }}=-100 \mu \mathrm{~A}$ | $0.9 * V_{\text {DD }}$ | - | $V_{D D}$ | V |
| $\mathrm{V}_{\text {OL1 }}$ | Logic Low Output Voltage | $\mathrm{I}_{\text {out }}=100 \mu \mathrm{~A}$ | 0 | - | $0.1 * V_{\text {DD }}$ | V |
| $\mathrm{V}_{\text {L6 }}$ | LCD Driving Voltage Source ( $\mathrm{V}_{\mathrm{L6}} \mathrm{Pin}$ ) | Regulator Enabled ( $\mathrm{V}_{\mathrm{L} 6}$ voltage depends on Int/Ext Contrast Control) | $\mathrm{V}_{\mathrm{EE}}{ }^{-0.5}$ | - | $\mathrm{V}_{\mathrm{DD}}$ | V |
| $\mathrm{V}_{\text {L6 }}$ | LCD Driving Voltage Source ( $\mathrm{V}_{\mathrm{L6}} \mathrm{Pin}$ ) | Regulator Disable | - | Floating | - | V |
| $\mathrm{V}_{\mathrm{H} 1}$ | Logic High Input voltage |  | $0.8 * V_{\text {DD }}$ | - | $V_{\text {DD }}$ | V |
| $\mathrm{V}_{\text {IL } 1}$ | Logic Low Input voltage |  | 0 | - | $0.2 * V_{\text {DD }}$ | V |
| $\begin{aligned} & \mathrm{V}_{\mathrm{L} 2} \\ & \mathrm{~V}_{\mathrm{L} 3} \\ & \mathrm{~V}_{\mathrm{L} 4} \\ & \mathrm{~V}_{\mathrm{L}} \\ & \mathrm{~V}_{\mathrm{L} 6} \end{aligned}$ | LCD Display Voltage Output $\left(\mathrm{V}_{\mathrm{L} 2}, \mathrm{~V}_{\mathrm{L} 3}, \mathrm{~V}_{\mathrm{L} 4}, \mathrm{~V}_{\mathrm{L} 5}, \mathrm{~V}_{\mathrm{L} 6}\right.$ Pins $)$ | Voltage reference to $\mathrm{V}_{\mathrm{DD}}$, Bias Divider Enabled, 1:a bias ratio | - - - - - | $\begin{gathered} 1 / a^{*} V_{\mathrm{L6}} \\ 2 / \mathrm{a}^{*} \mathrm{~V}_{\mathrm{L6}} \\ (\mathrm{a}-2) / \mathrm{a}^{*} \mathrm{~V}_{\mathrm{L6}} \\ (\mathrm{a}-1) / \mathrm{a}^{*} \mathrm{~V}_{\mathrm{L6}} \\ \mathrm{~V}_{\mathrm{L} 6} \end{gathered}$ | - - - - - | $\begin{aligned} & V \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ |
| $\mathrm{V}_{\mathrm{L} 2}$ | LCD Display Voltage Input | Voltage reference to $\mathrm{V}_{\mathrm{DD}}$, External Volt- | $\mathrm{V}_{\mathrm{L} 3}$ | - | $\mathrm{V}_{\mathrm{DD}}$ | V |
| $\mathrm{V}_{\mathrm{L} 3}$ | $\left(\mathrm{V}_{\mathrm{L} 2}, \mathrm{~V}_{\mathrm{L} 3}, \mathrm{~V}_{\mathrm{L} 4}, \mathrm{~V}_{\mathrm{L} 5}, \mathrm{~V}_{\mathrm{L} 6}\right.$ Pins $)$ | age Generator, Bias Divider Disabled | $V_{\text {L4 }}$ | - | $\mathrm{V}_{\mathrm{L} 2}$ | V |
| $V_{\text {L4 }}$ |  |  | $\mathrm{V}_{\text {L5 }}$ | - | $\mathrm{V}_{\mathrm{L} 3}$ | V |
| $\mathrm{V}_{\text {L5 }}$ |  |  | $\mathrm{V}_{\text {L6 }}$ | - | $\mathrm{V}_{\text {L4 }}$ | V |
| $\mathrm{V}_{\text {L6 }}$ |  |  | -12V | - | $\mathrm{V}_{\mathrm{L} 5}$ | V |
| $\mathrm{IOH}^{\text {O }}$ | Logic High Output Current Source | $\mathrm{V}_{\text {out }}=\mathrm{V}_{\text {DD }}-0.4 \mathrm{~V}$ | 50 | - | - | $\mu \mathrm{A}$ |
| lOL | Logic Low Output Current Drain | $\mathrm{V}_{\text {out }}=0.4 \mathrm{~V}$ | - | - | -50 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{OZ}}$ | Logic Output Tri-state Current Drain Source |  | -1 | - | 1 | $\mu \mathrm{A}$ |
| $I_{\text {IL }} I_{\text {IH }}$ | Logic Input Current |  | -1 | - | 1 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\text {IN }}$ | Logic Pins Input Capacitance |  | - | 5 | 7.5 | pF |
| $\Delta \mathrm{V}_{\mathrm{L} 6}$ | Variation of $\mathrm{V}_{L 6}$ Output ( $\mathrm{V}_{\mathrm{DD}}$ is fixed) | Regulator Enabled, Internal Contrast Control Enabled, Set Contrast Control Register $=0$ | -3 | 0 | 3 | \% |
|  | Temperature Coefficient Compensation |  |  |  |  |  |
| TC0 | Flat Temperature Coefficient (POR) | Voltage Regulator Enabled | 0 | -0.01 | -0.12 | \% ${ }^{\circ} \mathrm{C}$ |
| TC2 | Temperature Coefficient 2* | Voltage Regulator Enabled | -0.12 | -0.15 | -0.17 | \% ${ }^{\circ} \mathrm{C}$ |
| TC4 | Temperature Coefficient 4* | Voltage Regulator Enabled | -0.17 | -0.20 | -0.25 | \% ${ }^{\circ} \mathrm{C}$ |
| TC7 | Temperature Coefficient 7* | Voltage Regulator Enabled | -0.25 | -0.30 | - | \% ${ }^{\circ} \mathrm{C}$ |

* The formula for the temperature coefficient is:
$\mathrm{TC}(\%)=\frac{\mathrm{V}_{\text {ref }} \text { at } 50^{\circ} \mathrm{C}-\mathrm{V}_{\text {ref }} \text { at } 0^{\circ} \mathrm{C}}{50^{\circ} \mathrm{C}-0^{\circ} \mathrm{C}} \times \frac{1}{\mathrm{~V}_{\text {ref }} \text { at } 25^{\circ} \mathrm{C}} \times 100 \%$


## AC CHARACTERISTICS

Table 11 AC Characteristics (Unless otherwise specified, Voltage Referenced to $\mathrm{V}_{\mathrm{SS}}, \mathrm{V}_{\mathrm{DD}}=2.4$ to $3.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.)

| Symbol | Parameter | Test Condition | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Fosc | Oscillation Frequency of Display Timing Generator for: <br> - SSD1815B | Internal Oscillator Enabled (default), $\mathrm{V}_{\mathrm{DD}}$ $=2.7 \mathrm{~V}$ <br> Remark: <br> Oscillation Frequency vs Temperature <br> change $\left(-20^{\circ} \mathrm{C}\right.$ to $\left.70^{\circ} \mathrm{C}\right):-0.5 \% /{ }^{\circ} \mathrm{C}$ * | 17 | 19 | 21 | kHz |
| $\mathrm{F}_{\text {FRM }}$ | Frame Frequency for: <br> - SSD1815B | $132 \times 64$ Graphic Display Mode, Display ON, Internal Oscillator Enabled <br> $132 \times 64$ Graphic Display Mode, Display ON, Internal Oscillator Disabled, External clock with freq., $\mathrm{F}_{\text {ext }}$ feeding to CL pin. |  | $\frac{F_{\text {OSC }}}{4 \times 65}$ |  | Hz |

* The formula for Oscillation Frequency vs Temperature Change:
$\%$ change $\left(F_{\text {osc }}\right)=\frac{\mathrm{F}_{\mathrm{osc}} \text { at } 70^{\circ} \mathrm{C}-\mathrm{F}_{\mathrm{osc}} \text { at }-20^{\circ} \mathrm{C}}{70^{\circ} \mathrm{C}-\left(-20^{\circ} \mathrm{C}\right)} \times \frac{1}{\mathrm{~F}_{\text {osc }} \text { at } 25^{\circ} \mathrm{C}} \times 100 \%$


Test Condition : VDD $=2.775 \mathrm{~V}, \mathrm{TA}=25^{\circ} \mathrm{C}$, default contrast and internal resistor gain are used.

Table 12 6800-Series MPU Parallel Interface Timing Characteristics ( $\mathrm{V}_{\mathrm{DD}}-\mathrm{V}_{\mathrm{SS}}=2.4$ to 3.5 V , $\mathrm{T}_{\mathrm{A}}=-30$ to $85^{\circ} \mathrm{C}$ )

| Symbol | Parameter | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\text {cycle }}$ | Clock Cycle Time | 300 | - | - | ns |
| $t_{\text {AS }}$ | Address Setup Time | 0 | - | - | ns |
| $\mathrm{t}_{\text {AH }}$ | Address Hold Time | 0 | - | - | ns |
| $\mathrm{t}_{\text {DSW }}$ | Write Data Setup Time | 40 | - | - | ns |
| $\mathrm{t}_{\text {DHW }}$ | Write Data Hold Time | 15 | - | - | ns |
| $\mathrm{t}_{\text {DHR }}$ | Read Data Hold Time | 20 | - | - | ns |
| $\mathrm{t}_{\mathrm{OH}}$ | Output Disable Time | - | - | 70 | ns |
| $\mathrm{t}_{\text {ACC }}$ | Access Time | - | - | 140 | ns |
| $\mathrm{PW}_{\text {CSL }}$ | Chip Select Low Pulse Width (read) Chip Select Low Pulse Width (write) | $\begin{gathered} 120 \\ 60 \end{gathered}$ | - | - | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |
| PW ${ }_{\text {CSH }}$ | Chip Select High Pulse Width (read) Chip Select High Pulse Width (write) | $\begin{aligned} & 60 \\ & 60 \end{aligned}$ | - | - | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |
| $t_{R}$ | Rise Time | - | - | 15 | ns |
| $\mathrm{t}_{\mathrm{F}}$ | Fall Time | - | - | 15 | ns |



Figure 11 6800-series MPU Parallel Interface Characteristics

Table 13 8080-Series MPU Parallel Interface Timing Characteristics ( $\mathrm{V}_{\mathrm{DD}}-\mathrm{V}_{\mathrm{SS}}=2.4$ to 3.5 V , $\mathrm{T}_{\mathrm{A}}=-30$ to $85^{\circ} \mathrm{C}$ )

| Symbol | Parameter | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\text {cycle }}$ | Clock Cycle Time | 300 | - | - | ns |
| $\mathrm{t}_{\mathrm{AS}}$ | Address Setup Time | 0 | - | - | ns |
| $\mathrm{t}_{\text {AH }}$ | Address Hold Time | 0 | - | - | ns |
| $\mathrm{t}_{\text {DSW }}$ | Write Data Setup Time | 40 | - | - | ns |
| $t_{\text {DHW }}$ | Write Data Hold Time | 15 | - | - | ns |
| $\mathrm{t}_{\text {DHR }}$ | Read Data Hold Time | 20 | - | - | ns |
| $\mathrm{t}_{\mathrm{OH}}$ | Output Disable Time | - | - | 70 | ns |
| ${ }_{\text {t }}{ }_{\text {cc }}$ | Access Time | - | - | 140 | ns |
| PW ${ }_{\text {CSL }}$ | Chip Select Low Pulse Width (read) Chip Select Low Pulse Width (write) | $\begin{gathered} 120 \\ 60 \end{gathered}$ |  |  | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |
| $\mathrm{PW}_{\text {CSH }}$ | Chip Select High Pulse Width (read) Chip Select High Pulse Width (write) | $\begin{aligned} & 60 \\ & 60 \end{aligned}$ |  |  | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |
| $\mathrm{t}_{\mathrm{R}}$ | Rise Time | - | - | 15 | ns |
| $\mathrm{t}_{\mathrm{F}}$ | Fall Time | - | - | 15 | ns |



Figure 12 8080-series MPU Parallel Interface Characteristics

Table 14 Serial Interface Timing Characteristics $\left(V_{D D}-V_{S S}=2.4\right.$ to $3.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-30$ to $\left.85^{\circ} \mathrm{C}\right)$

| Symbol | Parameter | Min | Typ | Max | Unit |
| :---: | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\text {cycle }}$ | Clock Cycle Time | 250 | - | - | ns |
| $\mathrm{t}_{\text {AS }}$ | Address Setup Time | 150 | - | - | ns |
| $\mathrm{t}_{\text {AH }}$ | Address Hold Time | 150 | - | - | ns |
| $\mathrm{t}_{\text {CSS }}$ | Chip Select Setup Time (for $\mathrm{D}_{7}$ input) | 120 | - | - | ns |
| $\mathrm{t}_{\text {CSH }}$ | Chip Select Hold Time (for $\mathrm{D}_{0}$ input) | 60 | - | - | ns |
| $\mathrm{t}_{\text {DSW }}$ | Write Data Setup Time | 100 | - | - | ns |
| $\mathrm{t}_{\text {DHW }}$ | Write Data Hold Time | 100 | - | - | ns |
| $\mathrm{t}_{\text {CLKL }}$ | Clock Low Time | 100 | - | - | ns |
| $\mathrm{t}_{\text {CLKH }}$ | Clock High Time | 100 | - | - | ns |
| $\mathrm{t}_{\mathrm{R}}$ | Rise Time | - | - | 15 | ns |
| $\mathrm{t}_{\mathrm{F}}$ | Fall Time | - | - | 15 | ns |



Figure 13 Serial Interface Characteristics

## APPLICATION EXAMPLES



Figure 14 Application Circuit of $132 \times 64$ plus 2 icon lines using SSD1815B, configured with: external $V_{E E}$, internal regulator, divider mode enabled (Command: 2B), 6800-series MPU parallel interface, internal oscillator and master mode.


Figure 15 Application Circuit of $132 \times 64$ plus 2 icon lines using SSD1815B, configured with all internal power control circuit enabled, 6800-series MPU parallel interface, internal oscillator and master mode.

## APPENDIX A - TAB INFORMATION



Figure 16 SSD1815BT TAB Drawing 1/2


Figure 17 SSD1815BT TAB Drawing 2/2


Figure 18 SSD1815BT2 TAB Drawing 1/2


Figure 19 SSD1815BT2 TAB Drawing 2/2

## APPENDIX B - TAB WHEEL INFORMATION



Figure 20 TAB Wheel Mechanical Drawing

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